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### **Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

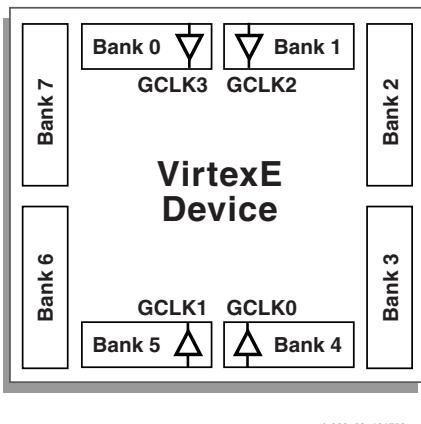
### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	7776
Number of Logic Elements/Cells	34992
Total RAM Bits	589824
Number of I/O	724
Number of Gates	2188742
Voltage - Supply	1.71V ~ 1.89V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1156-BBGA
Supplier Device Package	1156-FBGA (35x35)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xcv1600e-6fg1156i">https://www.e-xfl.com/product-detail/xilinx/xcv1600e-6fg1156i</a>

Eight I/O banks result from separating each edge of the FPGA into two banks, as shown in [Figure 3](#). Each bank has multiple  $V_{CCO}$  pins, all of which must be connected to the same voltage. This voltage is determined by the output standards in use.



*Figure 3: Virtex-E I/O Banks*

Within a bank, output standards can be mixed only if they use the same  $V_{CCO}$ . Compatible standards are shown in [Table 2](#). GTL and GTL+ appear under all voltages because their open-drain outputs do not depend on  $V_{CCO}$ .

*Table 2: Compatible Output Standards*

$V_{CCO}$	Compatible Standards
3.3 V	PCI, LVTTI, SSTL3 I, SSTL3 II, CTT, AGP, GTL, GTL+, LVPECL
2.5 V	SSTL2 I, SSTL2 II, LVCMOS2, GTL, GTL+, BLVDS, LVDS
1.8 V	LVCMOS18, GTL, GTL+
1.5 V	HSTL I, HSTL III, HSTL IV, GTL, GTL+

Some input standards require a user-supplied threshold voltage,  $V_{REF}$ . In this case, certain user-I/O pins are automatically configured as inputs for the  $V_{REF}$  voltage. Approximately one in six of the I/O pins in the bank assume this role.

The  $V_{REF}$  pins within a bank are interconnected internally and consequently only one  $V_{REF}$  voltage can be used within each bank. All  $V_{REF}$  pins in the bank, however, must be connected to the external voltage source for correct operation.

Within a bank, inputs that require  $V_{REF}$  can be mixed with those that do not. However, only one  $V_{REF}$  voltage can be used within a bank.

In Virtex-E, input buffers with LVTTI, LVCMOS2, LVCMOS18, PCI33\_3, PCI66\_3 standards are supplied by  $V_{CCO}$  rather than  $V_{CCINT}$ . For these standards, only input and output buffers that have the same  $V_{CCO}$  can be mixed together.

The  $V_{CCO}$  and  $V_{REF}$  pins for each bank appear in the device pin-out tables and diagrams. The diagrams also show the bank affiliation of each I/O.

Within a given package, the number of  $V_{REF}$  and  $V_{CCO}$  pins can vary depending on the size of device. In larger devices, more I/O pins convert to  $V_{REF}$  pins. Since these are always a super set of the  $V_{REF}$  pins used for smaller devices, it is possible to design a PCB that permits migration to a larger device if necessary. All the  $V_{REF}$  pins for the largest device anticipated must be connected to the  $V_{REF}$  voltage, and not used for I/O.

In smaller devices, some  $V_{CCO}$  pins used in larger devices do not connect within the package. These unconnected pins can be left unconnected externally, or can be connected to the  $V_{CCO}$  voltage to permit migration to a larger device if necessary.

## Configurable Logic Blocks

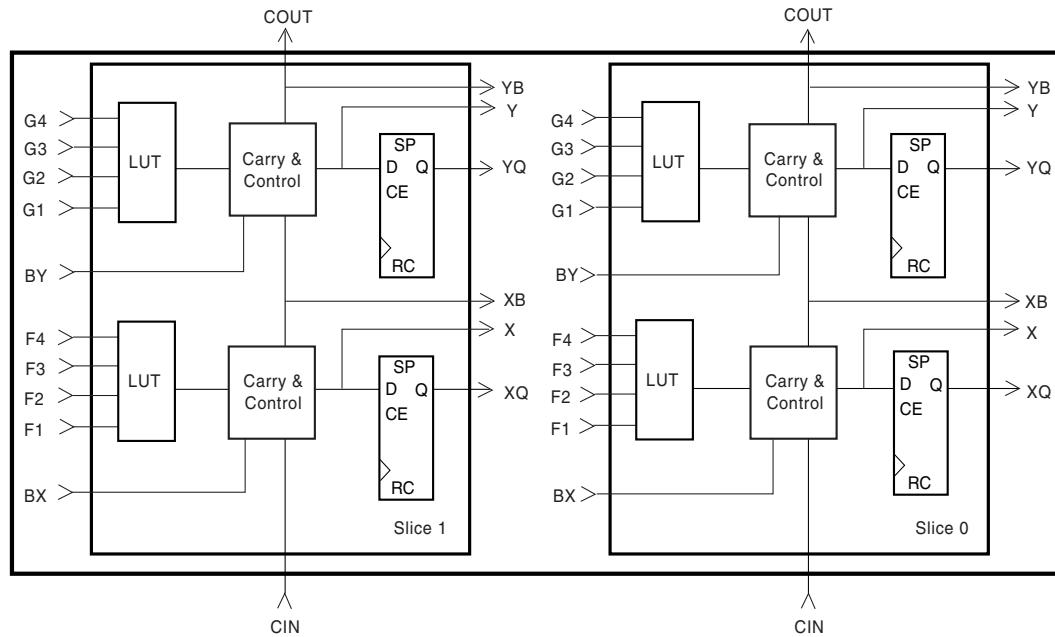
The basic building block of the Virtex-E CLB is the logic cell (LC). An LC includes a 4-input function generator, carry logic, and a storage element. The output from the function generator in each LC drives both the CLB output and the D input of the flip-flop. Each Virtex-E CLB contains four LCs, organized in two similar slices, as shown in [Figure 4](#). [Figure 5](#) shows a more detailed view of a single slice.

In addition to the four basic LCs, the Virtex-E CLB contains logic that combines function generators to provide functions of five or six inputs. Consequently, when estimating the number of system gates provided by a given device, each CLB counts as 4.5 LCs.

## Look-Up Tables

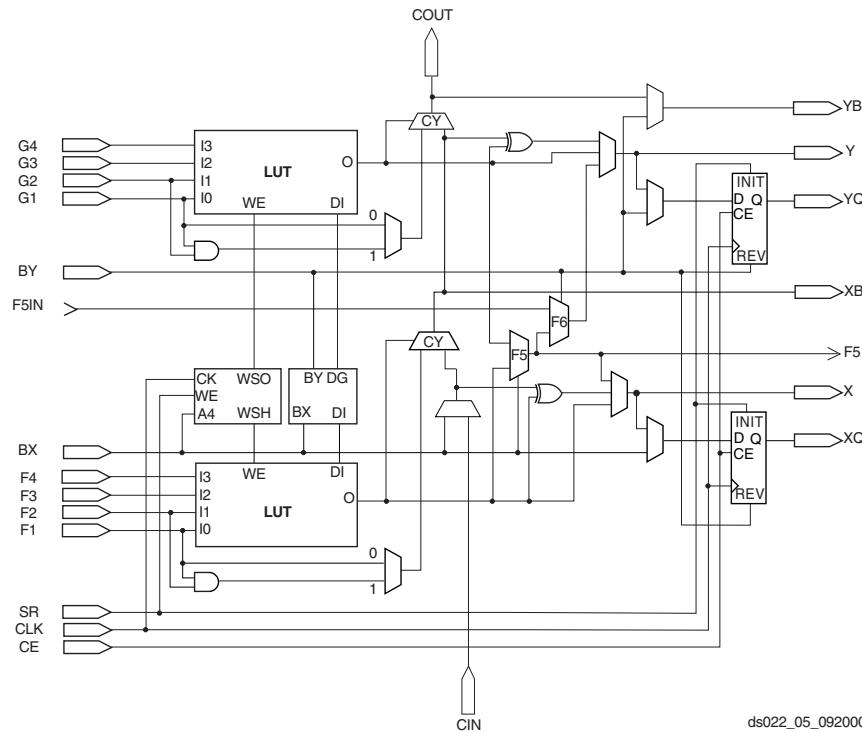
Virtex-E function generators are implemented as 4-input look-up tables (LUTs). In addition to operating as a function generator, each LUT can provide a 16 x 1-bit synchronous RAM. Furthermore, the two LUTs within a slice can be combined to create a 16 x 2-bit or 32 x 1-bit synchronous RAM, or a 16 x 1-bit dual-port synchronous RAM.

The Virtex-E LUT can also provide a 16-bit shift register that is ideal for capturing high-speed or burst-mode data. This mode can also be used to store data in applications such as Digital Signal Processing.



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Figure 4: 2-Slice Virtex-E CLB



ds022\_05\_092000

Figure 5: Detailed View of Virtex-E Slice

### Storage Elements

The storage elements in the Virtex-E slice can be configured either as edge-triggered D-type flip-flops or as level-sensitive latches. The D inputs can be driven either by

the function generators within the slice or directly from slice inputs, bypassing the function generators.

In addition to Clock and Clock Enable signals, each Slice has synchronous set and reset signals (SR and BY). SR

Configuration through the TAP uses the CFG\_IN instruction. This instruction allows data input on TDI to be converted into data packets for the internal configuration bus.

The following steps are required to configure the FPGA through the Boundary Scan port (when using TCK as a start-up clock).

1. Load the CFG\_IN instruction into the Boundary Scan instruction register (IR).
2. Enter the Shift-DR (SDR) state.
3. Shift a configuration bitstream into TDI.
4. Return to Run-Test-Idle (RTI).
5. Load the JSTART instruction into IR.
6. Enter the SDR state.
7. Clock TCK through the startup sequence.
8. Return to RTI.

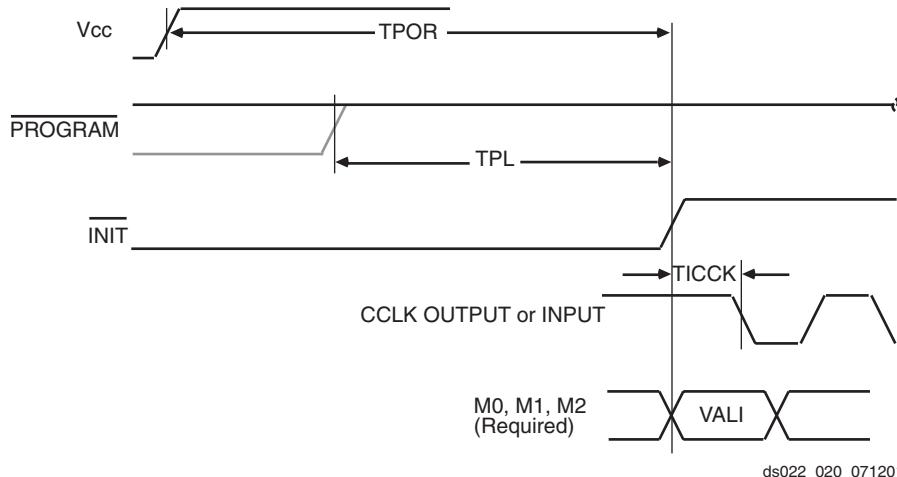
Configuration and readback via the TAP is always available. The Boundary Scan mode is selected by a  $<101>$  or  $<001>$  on the mode pins (M2, M1, M0). For details on TAP characteristics, refer to XAPP139.

## Configuration Sequence

The configuration of Virtex-E devices is a three-phase process. First, the configuration memory is cleared. Next, configuration data is loaded into the memory, and finally, the logic is activated by a start-up process.

Configuration is automatically initiated on power-up unless it is delayed by the user, as described below. The configuration process can also be initiated by asserting PROGRAM. The end of the memory-clearing phase is signalled by INIT going High, and the completion of the entire process is signalled by DONE going High.

The power-up timing of configuration signals is shown in [Figure 20](#).



*Figure 20: Power-Up Timing Configuration Signals*

The corresponding timing characteristics are listed in [Table 12](#).

*Table 12: Power-up Timing Characteristics*

Description	Symbol	Value	Units
Power-on Reset <sup>1</sup>	T <sub>POR</sub>	2.0	ms, max
Program Latency	T <sub>PL</sub>	100.0	μs, max
CCLK (output) Delay	T <sub>CCK</sub>	0.5	μs, min
		4.0	μs, max
Program Pulse Width	T <sub>PROGRAM</sub>	300	ns, min

### Notes:

1. T<sub>POR</sub> delay is the initialization time required after V<sub>CCINT</sub> and V<sub>CCO</sub> in Bank 2 reach the recommended operating voltage.

## Delaying Configuration

INIT can be held Low using an open-drain driver. An open-drain is required since INIT is a bidirectional open-drain pin that is held Low by the FPGA while the configuration memory is being cleared. Extending the time that the pin is Low causes the configuration sequencer to wait. Thus, configuration is delayed by preventing entry into the phase where data is loaded.

## Start-Up Sequence

The default Start-up sequence is that one CCLK cycle after DONE goes High, the global 3-state signal (GTS) is released. This permits device outputs to turn on as necessary.

One CCLK cycle later, the Global Set/Reset (GSR) and Global Write Enable (GWE) signals are released. This permits

## Virtex-E Data Sheet

The Virtex-E Data Sheet contains the following modules:

- DS022-1, Virtex-E 1.8V FPGAs:  
[Introduction and Ordering Information \(Module 1\)](#)
- DS022-2, Virtex-E 1.8V FPGAs:  
[Functional Description \(Module 2\)](#)
- DS022-3, Virtex-E 1.8V FPGAs:  
[DC and Switching Characteristics \(Module 3\)](#)
- DS022-4, Virtex-E 1.8V FPGAs:  
[Pinout Tables \(Module 4\)](#)

## Calculation of $T_{loop}$ as a Function of Capacitance

$T_{loop}$  is the propagation delay from the O Input of the IOB to the pad. The values for  $T_{loop}$  are based on the standard capacitive load ( $C_{sl}$ ) for each I/O standard as listed in [Table 3](#).

**Table 3: Constants for Use in Calculation of  $T_{loop}$**

Standard	$C_{sl}$ (pF)	$f_l$ (ns/pF)
LVTTL Fast Slew Rate, 2mA drive	35	0.41
LVTTL Fast Slew Rate, 4mA drive	35	0.20
LVTTL Fast Slew Rate, 6mA drive	35	0.13
LVTTL Fast Slew Rate, 8mA drive	35	0.079
LVTTL Fast Slew Rate, 12mA drive	35	0.044
LVTTL Fast Slew Rate, 16mA drive	35	0.043
LVTTL Fast Slew Rate, 24mA drive	35	0.033
LVTTL Slow Slew Rate, 2mA drive	35	0.41
LVTTL Slow Slew Rate, 4mA drive	35	0.20
LVTTL Slow Slew Rate, 6mA drive	35	0.10
LVTTL Slow Slew Rate, 8mA drive	35	0.086
LVTTL Slow Slew Rate, 12mA drive	35	0.058
LVTTL Slow Slew Rate, 16mA drive	35	0.050
LVTTL Slow Slew Rate, 24mA drive	35	0.048
LVCMOS2	35	0.041
LVCMOS18	35	0.050
PCI 33 MHZ 3.3 V	10	0.050
PCI 66 MHz 3.3 V	10	0.033
GTL	0	0.014
GTL+	0	0.017
HSTL Class I	20	0.022
HSTL Class III	20	0.016
HSTL Class IV	20	0.014
SSTL2 Class I	30	0.028
SSTL2 Class II	30	0.016
SSTL3 Class I	30	0.029
SSTL3 Class II	30	0.016
CTT	20	0.035
AGP	10	0.037

### Notes:

- I/O parameter measurements are made with the capacitance values shown above. See the application examples (in Module 2 of this data sheet) for appropriate terminations.
- I/O standard measurements are reflected in the IBIS model information except where the IBIS format precludes it.

For other capacitive loads, use the formulas below to calculate the corresponding  $T_{loop}$ :

$$T_{loop} = T_{loop} + T_{opadjust} + (C_{load} - C_{sl}) * f_l$$

where:

$T_{opadjust}$  is reported above in the Output Delay Adjustment section.

$C_{load}$  is the capacitive load for the design.

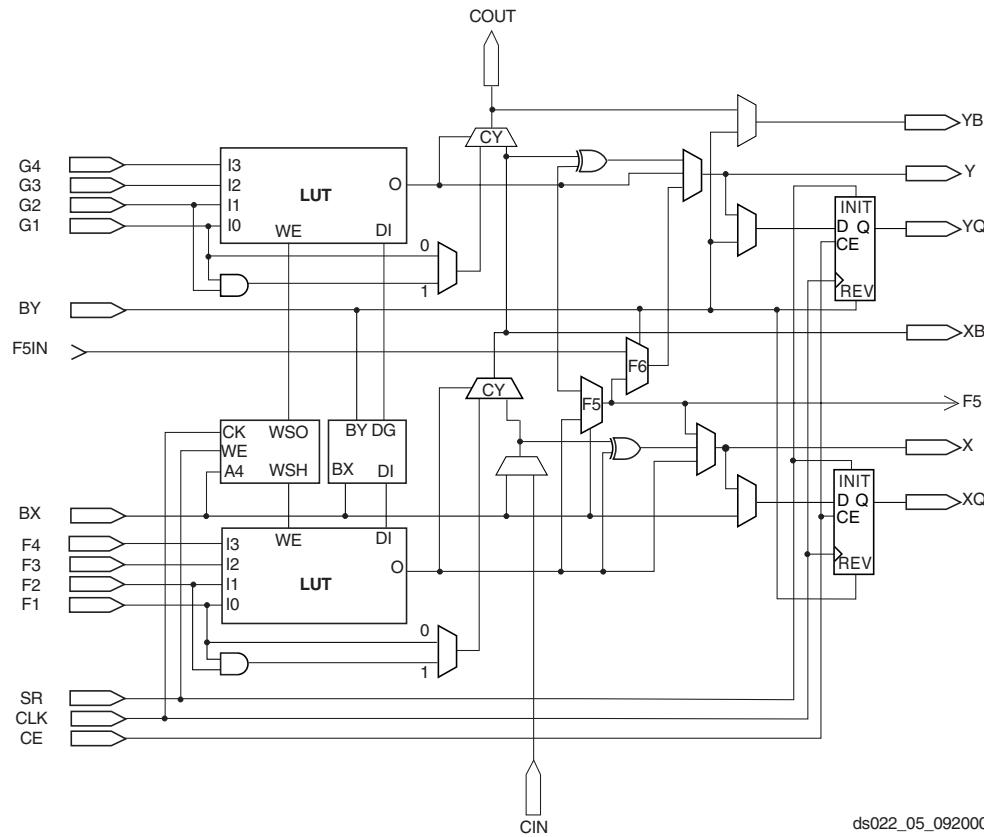
**Table 4: Delay Measurement Methodology**

Standard	$V_L^1$	$V_H^1$	Meas. Point	$V_{REF}$ (Typ) <sup>2</sup>
LVTTL	0	3	1.4	-
LVCMOS2	0	2.5	1.125	-
PCI33_3	Per PCI Spec		-	
PCI66_3	Per PCI Spec		-	
GTL	$V_{REF} - 0.2$	$V_{REF} + 0.2$	$V_{REF}$	0.80
GTL+	$V_{REF} - 0.2$	$V_{REF} + 0.2$	$V_{REF}$	1.0
HSTL Class I	$V_{REF} - 0.5$	$V_{REF} + 0.5$	$V_{REF}$	0.75
HSTL Class III	$V_{REF} - 0.5$	$V_{REF} + 0.5$	$V_{REF}$	0.90
HSTL Class IV	$V_{REF} - 0.5$	$V_{REF} + 0.5$	$V_{REF}$	0.90
SSTL3 I & II	$V_{REF} - 1.0$	$V_{REF} + 1.0$	$V_{REF}$	1.5
SSTL2 I & II	$V_{REF} - 0.75$	$V_{REF} + 0.75$	$V_{REF}$	1.25
CTT	$V_{REF} - 0.2$	$V_{REF} + 0.2$	$V_{REF}$	1.5
AGP	$V_{REF} - (0.2 \times V_{CCO})$	$V_{REF} + (0.2 \times V_{CCO})$	$V_{REF}$	Per AGP Spec
LVDS	1.2 – 0.125	1.2 + 0.125	1.2	
LVPECL	1.6 – 0.3	1.6 + 0.3	1.6	

### Notes:

- Input waveform switches between  $V_L$  and  $V_H$ .
  - Measurements are made at  $V_{REF}$  (Typ), Maximum, and Minimum. Worst-case values are reported.
- I/O parameter measurements are made with the capacitance values shown in [Table 3](#). See the application examples (in Module 2 of this data sheet) for appropriate terminations.

I/O standard measurements are reflected in the IBIS model information except where the IBIS format precludes it.



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Figure 2: Detailed View of Virtex-E Slice

## DLL Clock Tolerance, Jitter, and Phase Information

All DLL output jitter and phase specifications determined through statistical measurement at the package pins using a clock mirror configuration and matched drivers.

Description	Symbol	$F_{CLKIN}$	CLKDLLHF		CLKDLL		Units
			Min	Max	Min	Max	
Input Clock Period Tolerance	$T_{IPTOL}$		-	1.0	-	1.0	ns
Input Clock Jitter Tolerance (Cycle to Cycle)	$T_{IJITCC}$		-	$\pm 150$	-	$\pm 300$	ps
Time Required for DLL to Acquire Lock <sup>(6)</sup>	$T_{LOCK}$	> 60 MHz	-	20	-	20	$\mu s$
		50 - 60 MHz	-	-	-	25	$\mu s$
		40 - 50 MHz	-	-	-	50	$\mu s$
		30 - 40 MHz	-	-	-	90	$\mu s$
		25 - 30 MHz	-	-	-	120	$\mu s$
Output Jitter (cycle-to-cycle) for any DLL Clock Output <sup>(1)</sup>	$T_{OJITCC}$			$\pm 60$		$\pm 60$	ps
Phase Offset between CLKIN and CLKO <sup>(2)</sup>	$T_{PHIO}$			$\pm 100$		$\pm 100$	ps
Phase Offset between Clock Outputs on the DLL <sup>(3)</sup>	$T_{PHOO}$			$\pm 140$		$\pm 140$	ps
Maximum Phase Difference between CLKIN and CLKO <sup>(4)</sup>	$T_{PHIOM}$			$\pm 160$		$\pm 160$	ps
Maximum Phase Difference between Clock Outputs on the DLL <sup>(5)</sup>	$T_{PHOOM}$			$\pm 200$		$\pm 200$	ps

### Notes:

1. **Output Jitter** is cycle-to-cycle jitter measured on the DLL output clock and is based on a maximum tap delay resolution, *excluding* input clock jitter.
2. **Phase Offset between CLKIN and CLKO** is the worst-case fixed time difference between rising edges of CLKIN and CLKO, *excluding* Output Jitter and input clock jitter.
3. **Phase Offset between Clock Outputs on the DLL** is the worst-case fixed time difference between rising edges of any two DLL outputs, *excluding* Output Jitter and input clock jitter.
4. **Maximum Phase Difference between CLKIN and CLKO** is the sum of Output Jitter and Phase Offset between CLKIN and CLKO, or the greatest difference between CLKIN and CLKO rising edges due to DLL alone (*excluding* input clock jitter).
5. **Maximum Phase Difference between Clock Outputs on the DLL** is the sum of Output Jitter and Phase Offset between any DLL clock outputs, or the greatest difference between any two DLL output rising edges due to DLL alone (*excluding* input clock jitter).
6. Add 30% to the value for industrial grade parts.

Table 10: BG352 — XCV100E, XCV200E, XCV300E

Bank	Pin Description	Pin #
0	IO	C15
0	IO	B15 <sup>1</sup>
0	IO_LVDS_DLL_L9N	A15
0	GCK3	D14
1	GCK2	B14
1	IO_LVDS_DLL_L9P	A13
1	IO	B13 <sup>1</sup>
1	IO_L10N	C13
1	IO_L10P	A12
1	IO_L11N_Y	B12
1	IO_VREF_1_L11P_Y	C12
1	IO_L12N_Y	A11
1	IO_L12P_Y	B11
1	IO	B10 <sup>1</sup>
1	IO_L13N	C11
1	IO_L13P	D11
1	IO	A9 <sup>1</sup>
1	IO_L14N YY	B9
1	IO_L14P YY	C10
1	IO_L15N YY	B8
1	IO_VREF_1_L15P YY	C9
1	IO_L16N_Y	D9
1	IO_L16P_Y	A7
1	IO	B7
1	IO	C8 <sup>1</sup>
1	IO	D8 <sup>1</sup>
1	IO_L17N YY	A6
1	IO_VREF_1_L17P YY	B6
1	IO_L18N YY	C7
1	IO_L18P YY	A4
1	IO	B5 <sup>1</sup>
1	IO_L19N YY	C6
1	IO_VREF_1_L19P YY	D6 <sup>2</sup>

Table 10: BG352 — XCV100E, XCV200E, XCV300E

Bank	Pin Description	Pin #
1	IO	B4
1	IO	C5 <sup>1</sup>
1	IO	A3 <sup>1</sup>
1	IO_WRITE_L20N YY	D5
1	IO_CS_L20P YY	C4
2	IO_DOUT_BUSY_L21P YY	E4
2	IO_DIN_D0_L21N YY	D3
2	IO	C2 <sup>1</sup>
2	IO	E3 <sup>1</sup>
2	IO	F4
2	IO_VREF_2_L22P YY	D2 <sup>2</sup>
2	IO_L22N YY	C1
2	IO	D1 <sup>1</sup>
2	IO_L23P YY	G4
2	IO_L23N YY	F3
2	IO_VREF_2_L24P_Y	E2
2	IO_L24N_Y	F2
2	IO	G3 <sup>1</sup>
2	IO	G2 <sup>1</sup>
2	IO_L25P	F1
2	IO_L25N	J4
2	IO	H3
2	IO_VREF_2_L26P_Y	H2
2	IO_D1_L26N_Y	G1
2	IO_D2_L27P YY	J3
2	IO_L27N YY	J2
2	IO	K3 <sup>1</sup>
2	IO_L28P	J1
2	IO_L28N	L4
2	IO	K2 <sup>1</sup>
2	IO_L29P YY	L3
2	IO_L29N YY	L2
2	IO_VREF_2_L30P_Y	M4

**Table 13: BG432 Differential Pin Pair Summary**  
**XCV300E, XCV400E, XC600E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
112	6	AB29	AB28	✓	VREF
113	6	AA29	AB31	✓	-
114	6	Y29	Y28	4	-
115	6	Y31	Y30	1	-
116	6	W30	W29	1	-
117	6	V29	V28	✓	VREF
118	6	U29	V30	4	-
119	6	U30	U28	1	VREF
120	7	R29	T31	✓	-
121	7	R31	R30	1	VREF
122	7	P28	P29	4	-
123	7	N30	P30	✓	VREF
124	7	N31	N28	1	-
125	7	M28	M29	1	-
126	7	L30	M30	4	-
127	7	K30	K31	✓	-
128	7	J30	K28	✓	VREF
129	7	J28	J29	1	VREF
130	7	G30	H30	4	-
131	7	F31	H28	✓	VREF
132	7	G28	G29	1	-
133	7	E30	E31	5	-
134	7	F28	F29	1	VREF
135	7	D30	D31	4	-
136	7	E28	E29	3	-

**Notes:**

1. AO in the XCV300E, 600E.
2. AO in the XCV300E.
3. AO in the XCV400E, 600E.
4. AO in the XCV300E, 400E.
5. AO in the XCV600E.

**BG560 Ball Grid Array Packages**

XCV1000E, XCV1600E, and XCV2000E devices in BG560 Ball Grid Array packages have footprint compatibility. Pins labeled I<sub>O</sub>\_VREF can be used as either in all parts unless device-dependent as indicated in the footnotes. If the pin is not used as V<sub>REF</sub> it can be used as general I/O. Immediately following Table 14, see Table 15 for Differential Pair information.

**Table 14: BG560 — XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E**

Bank	Pin Description	Pin#	See Note
0	GCK3	A17	
0	IO	A27	
0	IO	B25	
0	IO	C28	
0	IO	C30	
0	IO	D30	
0	IO_L0N	E28	
0	IO_VREF_L0P	D29	3
0	IO_L1N_YY	D28	
0	IO_L1P_YY	A31	
0	IO_VREF_L2N_YY	E27	
0	IO_L2P_YY	C29	
0	IO_L3N_Y	B30	
0	IO_L3P_Y	D27	
0	IO_L4N_YY	E26	
0	IO_L4P_YY	B29	
0	IO_VREF_L5N_YY	D26	
0	IO_L5P_YY	C27	
0	IO_L6N_Y	E25	
0	IO_VREF_L6P_Y	A28	1
0	IO_L7N_Y	D25	
0	IO_L7P_Y	C26	
0	IO_VREF_L8N_Y	E24	4
0	IO_L8P_Y	B26	
0	IO_L9N_Y	C25	
0	IO_L9P_Y	D24	
0	IO_VREF_L10N_YY	E23	
0	IO_L10P_YY	A25	
0	IO_L11N_YY	D23	

## BG560 Differential Pin Pairs

Virtex-E devices have differential pin pairs that can also provide other functions when not used as a differential pair. A √ in the AO column indicates that the pin pair can be used as an asynchronous output for all devices provided in this package. Pairs with a note number in the AO column are device dependent. They can have asynchronous outputs if the pin pair are in the same CLB row and column in the device. Numbers in this column refer to footnotes that indicate which devices have pin pairs than can be asynchronous outputs. The Other Functions column indicates alternative function(s) not available when the pair is used as a differential pair or differential clock.

**Table 15: BG560 Differential Pin Pair Summary  
XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
Global Differential Clock					
0	4	AL17	AM17	NA	IO_DLL_L15P
1	5	AJ17	AM18	NA	IO_DLL_L15N
2	1	D17	E17	NA	IO_DLL_L21P
3	0	A17	C18	NA	IO_DLL_L21N
IO LVDS					
Total Outputs: 183, Asynchronous Outputs: 87					
0	0	D29	E28	8	VREF
1	0	A31	D28	√	-
2	0	C29	E27	√	VREF
3	0	D27	B30	3	-
4	0	B29	E26	√	-
5	0	C27	D26	√	VREF
6	0	A28	E25	9	VREF
7	0	C26	D25	7	-
8	0	B26	E24	7	VREF
9	0	D24	C25	2	-
10	0	A25	E23	√	VREF
11	0	B24	D23	√	-
12	0	C23	E22	8	-
13	0	D22	A23	√	-
14	0	B22	E21	√	VREF
15	0	C21	D21	3	-

**Table 15: BG560 Differential Pin Pair Summary  
XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
16	0	E20	B21	√	-
17	0	C20	D20	√	VREF
18	0	E19	B20	9	-
19	0	C19	D19	7	-
20	0	D18	A19	7	VREF
21	1	E17	C18	NA	IO_LVDS_DLL
22	1	B17	C17	2	VREF
23	1	D16	B16	7	VREF
24	1	C16	E16	7	-
25	1	C15	A15	9	-
26	1	E15	D15	√	VREF
27	1	D14	C14	√	-
28	1	E14	A13	3	-
29	1	D13	C13	√	VREF
30	1	E13	C12	√	-
31	1	D12	A11	8	-
32	1	C11	B11	√	-
33	1	D11	B10	√	VREF
34	1	A9	C10	10	-
35	1	D10	C9	7	VREF
36	1	B8	A8	7	-
37	1	C8	E10	5	VREF
38	1	A6	B7	√	VREF
39	1	D8	C7	√	-
40	1	B5	A5	11	-
41	1	D7	C6	√	VREF
42	1	B4	A4	√	-
43	1	E7	C5	12	VREF
44	1	A2	D6	√	CS
45	2	D4	E4	√	DIN, D0
46	2	F5	B3	17	VREF

**Table 17: FG256 Differential Pin Pair Summary  
XCV50E, XCV100E, XCV200E, XCV300E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
19	2	C15	D14	✓	DIN, D0
20	2	B16	E13	6	VREF
21	2	C16	E14	✓	-
22	2	F13	E15	1	VREF
23	2	F12	D16	5	-
24	2	F14	E16	3	D1
25	2	F15	G13	✓	D2
26	2	F16	G12	6	-
27	2	G15	G14	✓	-
28	2	H13	G16	3	D3
29	2	J13	H15	4	-
30	2	H14	H16	✓	-
31	3	K15	J14	4	-
32	3	J16	K16	3	VREF
33	3	K12	L15	✓	-
34	3	K13	L16	6	-
35	3	K14	M16	✓	D5
36	3	N16	L13	3	VREF
37	3	P16	L12	5	-
38	3	M15	L14	1	VREF
39	3	M14	R16	✓	-
40	3	M13	T15	6	VREF
41	3	N14	N15	✓	INIT
42	4	T14	P13	✓	-
43	4	P12	R13	7	VREF
44	4	N12	T13	✓	-
45	4	T12	P11	✓	VREF
46	4	R12	N11	2	-
47	4	T11	M11	✓	VREF
48	4	R11	T10	✓	-
49	4	R10	M10	1	-
50	4	P9	T9	1	VREF
51	4	N10	R9	1	-
52	5	N9	T8	NA	IO_LVDS_DLL
53	5	R7	P8	1	VREF
54	5	P7	T6	1	-

**Table 17: FG256 Differential Pin Pair Summary  
XCV50E, XCV100E, XCV200E, XCV300E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
55	5	M7	R6	✓	-
56	5	P6	R5	✓	VREF
57	5	N6	T5	2	-
58	5	M6	T4	✓	VREF
59	5	T3	P5	✓	-
60	5	T2	N5	7	VREF
61	6	R1	M3	✓	-
62	6	N2	M4	6	VREF
63	6	P1	L5	✓	-
64	6	L3	N1	1	VREF
65	6	L4	M2	5	-
66	6	K4	M1	3	VREF
67	6	L1	L2	✓	-
68	6	K1	K3	6	-
69	6	K5	K2	✓	-
70	6	J1	J3	3	VREF
71	6	H1	J4	4	-
72	7	H4	G1	✓	-
73	7	H2	G5	4	-
74	7	H3	G4	3	VREF
75	7	F5	G2	✓	-
76	7	F1	F4	6	-
77	7	F2	G3	✓	-
78	7	D1	E1	3	VREF
79	7	E2	E4	5	-
80	7	C1	F3	1	VREF
81	7	E3	D2	✓	-
82	7	A2	B1	6	VREF

**Notes:**

1. AO in the XCV50E, 200E, 300E.
2. AO in the XCV50E, 200E.
3. AO in the XCV50E, 300E.
4. AO in the XCV100E, 200E.
5. AO in the XCV200E.
6. AO in the XCV100E.
7. AO in the XCV50E.

**Table 18: FG456 — XCV200E and XCV300E**

<b>Bank</b>	<b>Pin Description</b>	<b>Pin #</b>
3	IO_L50N_YY	P19
3	IO_L51P_YY	P18
3	IO_D5_L51N_YY	R21
3	IO_D6_L52P_Y	T22
3	IO_VREF_L52N_Y	R19
3	IO_L53P_Y	U22
3	IO_L53N_Y	R18
3	IO_L54P_YY	T21
3	IO_L54N_YY	V22
3	IO_L55P_YY	T20
3	IO_VREF_L55N_YY	U21
3	IO_L56P_YY	W22
3	IO_L56N_YY	T18
3	IO_L57P_YY	U19
3	IO_VREF_L57N_YY	U20
3	IO_L58P_YY	W21
3	IO_L58N_YY	AA22
3	IO_D7_L59P_YY	Y21
3	IO_INIT_L59N_YY	V19
3	IO	M22
4	GCK0	W12
4	IO	W14
4	IO	Y13
4	IO	Y17
4	IO	AA16 <sup>1</sup>
4	IO	AA19
4	IO	AB12 <sup>1</sup>
4	IO	AB17
4	IO	AB21 <sup>1</sup>
4	IO_L60P_YY	W18
4	IO_L60N_YY	AA20
4	IO_L61P	Y18
4	IO_L61N	V17
4	IO_VREF_L62P_YY	AB20
4	IO_L62N_YY	W17
4	IO_L63P	AA18

**Table 18: FG456 — XCV200E and XCV300E**

<b>Bank</b>	<b>Pin Description</b>	<b>Pin #</b>
4	IO_L63N	V16
4	IO_VREF_L64P_YY	AB19
4	IO_L64N_YY	AB18
4	IO_L65P_Y	W16
4	IO_L65N_Y	AA17
4	IO_L66P_Y	Y16
4	IO_L66N_Y	V15
4	IO_VREF_L67P_YY	AB16
4	IO_L67N_YY	Y15
4	IO_L68P_YY	AA15
4	IO_L68N_YY	AB15
4	IO_L69P_Y	W15
4	IO_L69N_Y	Y14
4	IO_L70P_Y	V14
4	IO_L70N_Y	AA14
4	IO_L71P	AB14
4	IO_L71N	V13
4	IO_VREF_L72P_YY	AA13
4	IO_L72N_YY	AB13
4	IO_L73P_Y	W13
4	IO_L73N_Y	AA12
4	IO_L74P_Y	Y12
4	IO_L74N_Y	V12
4	IO_LVDS_DLL_L75P	U12
5	IO	U11 <sup>1</sup>
5	IO	V8
5	IO	W5
5	IO	AA3 <sup>1</sup>
5	IO	AA9
5	IO	AA10
5	IO	AB4
5	IO	AB7 <sup>1</sup>
5	IO	AB8
5	GCK1	Y11
5	IO_LVDS_DLL_L75N	AA11
5	IO_L76P_Y	AB11

Table 18: FG456 — XCV200E and XCV300E

Bank	Pin Description	Pin #
NA	VCCINT	T15
NA	VCCINT	T16
NA	VCCINT	U6
NA	VCCINT	U17
NA	VCCINT	V5
NA	VCCINT	V18
NA	VCCO_7	L7
NA	VCCO_7	K7
NA	VCCO_7	K6
NA	VCCO_7	J6
NA	VCCO_7	H6
NA	VCCO_7	G6
NA	VCCO_6	N7
NA	VCCO_6	M7
NA	VCCO_6	T6
NA	VCCO_6	R6
NA	VCCO_6	P6
NA	VCCO_6	N6
NA	VCCO_5	U10
NA	VCCO_5	U9
NA	VCCO_5	U8
NA	VCCO_5	U7
NA	VCCO_5	T11
NA	VCCO_5	T10
NA	VCCO_4	U16
NA	VCCO_4	U15
NA	VCCO_4	U14
NA	VCCO_4	U13
NA	VCCO_4	T13
NA	VCCO_4	T12
NA	VCCO_3	T17
NA	VCCO_3	R17
NA	VCCO_3	P17
NA	VCCO_3	N17
NA	VCCO_3	N16
NA	VCCO_3	M16

Table 18: FG456 — XCV200E and XCV300E

Bank	Pin Description	Pin #
NA	VCCO_2	K17
NA	VCCO_2	J17
NA	VCCO_2	H17
NA	VCCO_2	G17
NA	VCCO_2	L16
NA	VCCO_2	K16
NA	VCCO_1	G13
NA	VCCO_1	G12
NA	VCCO_1	F16
NA	VCCO_1	F15
NA	VCCO_1	F14
NA	VCCO_1	F13
NA	VCCO_0	G11
NA	VCCO_0	G10
NA	VCCO_0	F10
NA	VCCO_0	F9
NA	VCCO_0	F8
NA	VCCO_0	F7
NA	GND	AB22
NA	GND	AB1
NA	GND	AA21
NA	GND	AA2
NA	GND	Y20
NA	GND	Y3
NA	GND	P14
NA	GND	P13
NA	GND	P12
NA	GND	P11
NA	GND	P10
NA	GND	P9
NA	GND	N14
NA	GND	N13
NA	GND	N12
NA	GND	N11
NA	GND	N10
NA	GND	N9

**Table 24: FG860 — XCV1000E, XCV1600E, XCV2000E**

<b>Bank</b>	<b>Pin Description</b>	<b>Pin #</b>
2	IO_D1_L87N_YY	P2
2	IO_D2_L88P_YY	P3
2	IO_L88N_YY	L4
2	IO_L89P_Y	P1
2	IO_L89N_Y	R2
2	IO_L90P_Y	M5
2	IO_L90N_Y	R3
2	IO_L91P_Y	M4
2	IO_L91N_Y	R1
2	IO_L92P	N4
2	IO_L92N	T2
2	IO_L93P_Y	P5
2	IO_L93N_Y	T3
2	IO_VREF_L94P_Y	P4
2	IO_L94N_Y	T1
2	IO_L95P_YY	U2
2	IO_L95N_YY	R4
2	IO_L96P_Y	U3
2	IO_L96N_Y	T5
2	IO_L97P_Y	T4
2	IO_L97N_Y	V2
2	IO_VREF_L98P_YY	U5
2	IO_D3_L98N_YY	V3
2	IO_L99P_YY	V1
2	IO_L99N_YY	V5
2	IO_L100P_Y	W2
2	IO_L100N_Y	V4
2	IO_L101P_Y	W5
2	IO_L101N_Y	W1
2	IO_VREF_L102P_YY	Y2
2	IO_L102N_YY	W4
2	IO_L103P_YY	Y1
2	IO_L103N_YY	Y5
2	IO_VREF_L104P_Y	AA1 <sup>1</sup>
2	IO_L104N_Y	Y4
2	IO_L105P_YY	AA4
2	IO_L105N_YY	AA2

**Table 24: FG860 — XCV1000E, XCV1600E, XCV2000E**

<b>Bank</b>	<b>Pin Description</b>	<b>Pin #</b>
3	IO	AB4
3	IO	AC2
3	IO	AD1
3	IO	AE3
3	IO	AF4
3	IO	AH5
3	IO	AJ2
3	IO	AL1
3	IO	AM3
3	IO	AP3
3	IO	AR5
3	IO	AU4
3	IO	AB2
3	IO_L106P_Y	AB3
3	IO_VREF_L106N_Y	AC4 <sup>1</sup>
3	IO_L107P_YY	AB1
3	IO_L107N_YY	AC5
3	IO_L108P_YY	AD4
3	IO_VREF_L108N_YY	AC3
3	IO_L109P_Y	AC1
3	IO_L109N_Y	AD5
3	IO_L110P_Y	AE4
3	IO_L110N_Y	AD3
3	IO_L111P_YY	AE5
3	IO_L111N_YY	AD2
3	IO_D4_L112P_YY	AE1
3	IO_VREF_L112N_YY	AF5
3	IO_L113P_Y	AE2
3	IO_L113N_Y	AG4
3	IO_L114P_Y	AG5
3	IO_L114N_Y	AF1
3	IO_L115P_YY	AH4
3	IO_L115N_YY	AF2
3	IO_L116P_Y	AF3
3	IO_VREF_L116N_Y	AJ4
3	IO_L117P_Y	AG1

Table 24: FG860 — XCV1000E, XCV1600E, XCV2000E

Bank	Pin Description	Pin #
5	IO_L178P_Y	BB23
5	IO_L178N_Y	AW23
5	IO_L179P_YY	AV23
5	IO_VREF_L179N_YY	BA23
5	IO_L180P_YY	AW24
5	IO_L180N_YY	BB24
5	IO_L181P_Y	AY24
5	IO_L181N_Y	AW25
5	IO_L182P_Y	BA24
5	IO_L182N_Y	AV25
5	IO_L183P_YY	AW26
5	IO_VREF_L183N_YY	AY25
5	IO_L184P_YY	AV26
5	IO_L184N_YY	BA25
5	IO_L185P_Y	BB26
5	IO_L185N_Y	AV27
5	IO_L186P_Y	AY26
5	IO_L186N_Y	AU27
5	IO_L187P_YY	AW28
5	IO_VREF_L187N_YY	BB27
5	IO_L188P_YY	AY27
5	IO_L188N_YY	AV28
5	IO_L189P_Y	BA27
5	IO_L189N_Y	AW29
5	IO_L190P_Y	BB28
5	IO_L190N_Y	AV29
5	IO_L191P_Y	AY28
5	IO_L191N_Y	AW30
5	IO_L192P_Y	BA28
5	IO_L192N_Y	AW31
5	IO_L193P_YY	BB29
5	IO_L193N_YY	AV31
5	IO_L194P_YY	AY29
5	IO_VREF_L194N_YY	AY32
5	IO_L195P_Y	AW32
5	IO_L195N_Y	BB30
5	IO_L196P_Y	AV32

Table 24: FG860 — XCV1000E, XCV1600E, XCV2000E

Bank	Pin Description	Pin #
5	IO_L196N_Y	AY30
5	IO_L197P_YY	BA30
5	IO_VREF_L197N_YY	AW33
5	IO_L198P_YY	BB31
5	IO_L198N_YY	AV33
5	IO_L199P_Y	AY34
5	IO_VREF_L199N_Y	BA31 <sup>2</sup>
5	IO_L200P_Y	AW34
5	IO_L200N_Y	BB32
5	IO_L201P_YY	BA32
5	IO_VREF_L201N_YY	AY35
5	IO_L202P_YY	BB33
5	IO_L202N_YY	AW35
5	IO_L203P_Y	AV35
5	IO_L203N_Y	BB34
5	IO_L204P_Y	AY36
5	IO_L204N_Y	BA34
5	IO_L205P_YY	BB35
5	IO_VREF_L205N_YY	AV36
5	IO_L206P_YY	BA35
5	IO_L206N_YY	AY37
5	IO_L207P_Y	BB36
5	IO_L207N_Y	BA36
5	IO_L208P_Y	AW37
5	IO_VREF_L208N_Y	BB37
5	IO_L209P_Y	BA37
5	IO_L209N_Y	AY38
5	IO_L210P_Y	BB38
5	IO_L210N_Y	AY39
6	IO	AA40
6	IO	AB41
6	IO	AC42
6	IO	AD39
6	IO	AE40
6	IO	AF38
6	IO	AF40

Table 24: FG860 — XCV1000E, XCV1600E, XCV2000E

Bank	Pin Description	Pin #
NA	VCCO_1	F15
NA	VCCO_1	F19
NA	VCCO_1	F20
NA	VCCO_1	F7
NA	VCCO_1	F8
NA	VCCO_2	G6
NA	VCCO_2	H6
NA	VCCO_2	L6
NA	VCCO_2	M6
NA	VCCO_2	P6
NA	VCCO_2	R6
NA	VCCO_2	W6
NA	VCCO_2	Y6
NA	VCCO_3	AC6
NA	VCCO_3	AD6
NA	VCCO_3	AH6
NA	VCCO_3	AJ6
NA	VCCO_3	AL6
NA	VCCO_3	AM6
NA	VCCO_3	AR6
NA	VCCO_3	AT6
NA	VCCO_4	AU11
NA	VCCO_4	AU12
NA	VCCO_4	AU14
NA	VCCO_4	AU15
NA	VCCO_4	AU19
NA	VCCO_4	AU20
NA	VCCO_4	AU7
NA	VCCO_4	AU8
NA	VCCO_5	AU23
NA	VCCO_5	AU24
NA	VCCO_5	AU28
NA	VCCO_5	AU29
NA	VCCO_5	AU31
NA	VCCO_5	AU32
NA	VCCO_5	AU35
NA	VCCO_5	AU36

Table 24: FG860 — XCV1000E, XCV1600E, XCV2000E

Bank	Pin Description	Pin #
NA	VCCO_6	AC37
NA	VCCO_6	AD37
NA	VCCO_6	AH37
NA	VCCO_6	AJ37
NA	VCCO_6	AL37
NA	VCCO_6	AM37
NA	VCCO_6	AR37
NA	VCCO_6	AT37
NA	VCCO_7	G37
NA	VCCO_7	H37
NA	VCCO_7	L37
NA	VCCO_7	M37
NA	VCCO_7	P37
NA	VCCO_7	R37
NA	VCCO_7	W37
NA	VCCO_7	Y37
NA	GND	N6
NA	GND	N5
NA	GND	N38
NA	GND	N37
NA	GND	F6
NA	GND	F37
NA	GND	F30
NA	GND	F22
NA	GND	F21
NA	GND	F13
NA	GND	E5
NA	GND	E38
NA	GND	E30
NA	GND	E22
NA	GND	E21
NA	GND	E13
NA	GND	D42
NA	GND	D4
NA	GND	D39
NA	GND	D1

**Table 27: FG900 Differential Pin Pair Summary  
XCV600E, XCV1000E, XCV1600E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
52	1	A22	C21	✓	VREF
53	1	B22	H19	4	-
54	1	D22	E21	4	-
55	1	C22	F21	✓	VREF
56	1	E22	H20	✓	-
57	1	A23	G21	2	-
58	1	K19	A24	2	-
59	1	B24	C24	✓	VREF
60	1	G22	H21	✓	-
61	1	C25	E23	1	-
62	1	A26	D24	1	-
63	1	K20	B26	✓	VREF
64	1	J21	D25	✓	-
65	1	F23	C26	2	-
66	1	G23	B27	2	VREF
67	1	F24	A27	2	-
68	1	A28	B28	4	-
69	1	C27	K21	✓	CS
70	2	J22	E27	✓	DIN, D0
71	2	C29	D28	NA	-
72	2	G25	E25	1	-
73	2	E28	C30	4	VREF
74	2	K22	F27	3	-
75	2	D30	J23	4	-
76	2	L21	F28	1	VREF
77	2	G28	E30	✓	-
78	2	G27	E29	4	-
79	2	K23	H26	1	-
80	2	F30	L22	✓	VREF
81	2	H27	G29	✓	-
82	2	G30	M21	2	-
83	2	J24	J26	4	-
84	2	H30	L23	4	VREF
85	2	K26	J28	4	-

**Table 27: FG900 Differential Pin Pair Summary  
XCV600E, XCV1000E, XCV1600E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
86	2	J29	K24	4	-
87	2	K27	J30	4	VREF
88	2	M22	K29	NA	D2
89	2	K28	L25	4	-
90	2	N21	K25	1	-
91	2	L24	L27	4	-
92	2	L29	M23	3	-
93	2	L26	L28	4	-
94	2	L30	M27	1	VREF
95	2	M26	M29	✓	-
96	2	N29	M30	4	-
97	2	N25	N27	1	-
98	2	N30	P21	✓	D3
99	2	N26	P28	✓	-
100	2	P29	N24	2	-
101	2	P22	R26	✓	-
102	2	P25	R29	4	VREF
103	2	R21	R28	4	-
104	2	R25	T30	4	VREF
105	2	P24	R27	4	-
106	3	R24	U29	NA	
107	3	R22	T27	4	VREF
108	3	R23	T28	4	-
109	3	T21	T25	4	VREF
110	3	U28	U30	4	-
111	3	T23	U27	2	-
112	3	U25	V27	✓	-
113	3	U24	V29	✓	VREF
114	3	W30	U22	1	-
115	3	U21	W29	4	-
116	3	V26	W27	✓	-
117	3	W26	Y29	1	VREF
118	3	W25	Y30	4	-
119	3	V24	Y28	3	-

**Table 28: FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

Bank	Pin Description	Pin #
0	IO_L40P_Y	A17
0	IO_VREF_L41N_Y	G17 <sup>1</sup>
0	IO_L41P_Y	B17
0	IO_LVDS_DLL_L42N	C17
1	GCK2	D17
1	IO	A18
1	IO	B18 <sup>3</sup>
1	IO	B24
1	IO	B25
1	IO	E22 <sup>3</sup>
1	IO	E23 <sup>3</sup>
1	IO	D18 <sup>3</sup>
1	IO	D19
1	IO	D25 <sup>3</sup>
1	IO	D26 <sup>3</sup>
1	IO	D28 <sup>3</sup>
1	IO	D29 <sup>3</sup>
1	IO	G23 <sup>3</sup>
1	IO	J23 <sup>3</sup>
1	IO_LVDS_DLL_L42P	J18
1	IO_L43N_Y	G18
1	IO_VREF_L43P_Y	C18 <sup>1</sup>
1	IO_L44N_Y	H18
1	IO_L44P_Y	F18
1	IO_L45N_YY	B19
1	IO_VREF_L45P_YY	A19
1	IO_L46N_YY	K19
1	IO_L46P_YY	C19
1	IO_L47N	F19 <sup>5</sup>
1	IO_L47P	E19 <sup>4</sup>
1	IO_L48N_Y	G19
1	IO_L48P_Y	J19
1	IO_L49N_Y	A20

**Table 28: FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

Bank	Pin Description	Pin #
1	IO_L49P_Y	G20
1	IO_L50N	B20 <sup>5</sup>
1	IO_L50P	F20 <sup>4</sup>
1	IO_L51N_YY	D20
1	IO_VREF_L51P_YY	E20
1	IO_L52N_YY	H20
1	IO_L52P_YY	A21
1	IO_L53N	E21 <sup>5</sup>
1	IO_L53P	J20 <sup>4</sup>
1	IO_L54N_Y	D21
1	IO_L54P_Y	K20
1	IO_L55N_Y	B21
1	IO_L55P_Y	H21
1	IO_L56N_YY	G21 <sup>5</sup>
1	IO_L56P_YY	F21 <sup>4</sup>
1	IO_L57N_YY	A22
1	IO_VREF_L57P_YY	B22
1	IO_L58N_YY	J21
1	IO_L58P_YY	C22
1	IO_L59N_Y	D22
1	IO_L59P_Y	G22
1	IO_L60N_Y	K21
1	IO_L60P_Y	A23
1	IO_L61N_Y	F22
1	IO_L61P_Y	B23
1	IO_L62N_Y	C23
1	IO_L62P_Y	H22
1	IO_L63N_YY	D23
1	IO_L63P_YY	K22
1	IO_L64N_YY	A24
1	IO_VREF_L64P_YY	J22
1	IO_L65N_Y	H23
1	IO_L65P_Y	D24
1	IO_L66N_Y	A25

**Table 28: FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

<b>Bank</b>	<b>Pin Description</b>	<b>Pin #</b>
4	IO_L212N_YY	AP18
4	IO_L213P_Y	AF18
4	IO_L213N_Y	AP17
4	IO_VREF_L214P_Y	AJ18 <sup>1</sup>
4	IO_L214N_Y	AL18
4	IO_LVDS_DLL_L215P	AM18
5	GCK1	AL19
5	IO	AF17 <sup>3</sup>
5	IO	AG12 <sup>3</sup>
5	IO	AH12
5	IO	AJ10 <sup>3</sup>
5	IO	AJ11 <sup>3</sup>
5	IO	AK7 <sup>3</sup>
5	IO	AK13 <sup>3</sup>
5	IO	AL13 <sup>3</sup>
5	IO	AM4 <sup>3</sup>
5	IO	AN9
5	IO	AN10 <sup>3</sup>
5	IO	AN16
5	IO	AN17 <sup>3</sup>
5	IO_LVDS_DLL_L215N	AL17
5	IO_L216P_Y	AH17
5	IO_VREF_L216N_Y	AM17 <sup>1</sup>
5	IO_L217P_Y	AJ17
5	IO_L217N_Y	AG17
5	IO_L218P_YY	AP16
5	IO_VREF_L218N_YY	AL16
5	IO_L219P_YY	AJ16
5	IO_L219N_YY	AM16
5	IO_L220P	AK16 <sup>5</sup>
5	IO_L220N	AP15 <sup>4</sup>
5	IO_L221P_Y	AL15
5	IO_L221N_Y	AH16

**Table 28: FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

<b>Bank</b>	<b>Pin Description</b>	<b>Pin #</b>
5	IO_L222P_Y	AN15
5	IO_L222N_Y	AF16
5	IO_L223P_Y	AP14 <sup>5</sup>
5	IO_L223N_Y	AE16 <sup>4</sup>
5	IO_L224P_YY	AK15
5	IO_VREF_L224N_YY	AJ15
5	IO_L225P_YY	AH15
5	IO_L225N_YY	AN14
5	IO_L226P	AK14 <sup>5</sup>
5	IO_L226N	AG15 <sup>4</sup>
5	IO_L227P_Y	AM13
5	IO_L227N_Y	AF15
5	IO_L228P_Y	AG14
5	IO_L228N_Y	AP13
5	IO_L229P_YY	AE14 <sup>5</sup>
5	IO_L229N_YY	AE15 <sup>4</sup>
5	IO_L230P_YY	AN13
5	IO_VREF_L230N_YY	AG13
5	IO_L231P_YY	AH14
5	IO_L231N_YY	AP12
5	IO_L232P_Y	AJ14
5	IO_L232N_Y	AL14
5	IO_L233P_Y	AF13
5	IO_L233N_Y	AN12
5	IO_L234P_Y	AF14
5	IO_L234N_Y	AP11
5	IO_L235P_Y	AN11
5	IO_L235N_Y	AH13
5	IO_L236P_YY	AM12
5	IO_L236N_YY	AL12
5	IO_L237P_Y	AJ13
5	IO_VREF_L237N_YY	AP10
5	IO_L238P_Y	AK12
5	IO_L238N_Y	AM10

**Table 29: FG1156 Differential Pin Pair Summary:  
XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
270	6	AG2	AE7	2600 2000 1000	-
271	6	AG1	AF6	3200 2600 2000 1600 1000	VREF
272	6	AG4	AC9	2000 1600	-
273	6	AF3	AE6	3200 2600 2000 1600 1000	-
274	6	AF4	AF1	2600 1000	VREF
275	6	AF2	AB10	3200 2600 1600	-
276	6	AE1	AC8	3200 2600 1600 1000	-
277	6	AE3	AD5	3200 2600 2000 1600 1000	VREF
278	6	AD1	AC7	3200 2600 2000 1600 1000	-
279	6	AD2	AD6	3200 1600 1000	-
280	6	AC1	AB8	2000 1600 1000	VREF
281	6	AC2	AC5	3200 2600 2000 1600 1000	-
282	6	AC3	AA9	3200 2600 2000	-
283	6	AD4	AC4	2000 1000	-
284	6	AB6	AA8	3200 2600 1600 1000	-
285	6	Y10	AB1	2600 1600	-
286	6	AA7	AB2	3200 1600 1000	-
287	6	AA1	AA4	2600 2000 1000	VREF
288	6	AB4	Y9	3200 2600 2000 1600	-
289	6	Y8	AA2	3200 2600 2000 1600 1000	-

**Table 29: FG1156 Differential Pin Pair Summary:  
XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
290	6	AA5	AA6	3200 2600 1600 1000	-
291	6	Y7	AB3	3200 2600 2000	-
292	6	W10	Y1	2600 2000 1000	-
293	6	Y2	Y5	2000 1600 1000	VREF
294	6	W2	W9	2000 1600	-
295	6	Y4	W7	3200 2600 2000 1600 1000	-
296	6	Y6	W1	1000	-
297	6	W3	W6	3200 1600	-
298	6	W4	V9	3200 2600 1600 1000	-
299	6	V1	W5	2000 1600 1000	VREF
300	6	U2	V7	2000 1600 1000	-
301	6	U1	V6	3200 2600 1600 1000	VREF
302	7	U4	U9	3200 2600 2000 1600 1000	-
303	7	U5	U7	3200 2600 1600 1000	VREF
304	7	U6	U3	2000 1600 1000	-
305	7	T6	T3	2000 1600 1000	VREF
306	7	T4	T9	3200 2600 1600 1000	-
307	7	R1	T5	3200 1600	-
308	7	T10	R6	1000	-
309	7	R5	R2	3200 2600 2000 1600 1000	-
310	7	P5	P1	2000 1600 1000	VREF